

Product Overview

The AG203-63 is a general-purpose buffer amplifier that offers high dynamic range in a low-cost surface-mount package. At 900 MHz, the AD203-63 typically provides 20 dB gain, +20 dBm OPI3, and +8 dBm P1dB. The device combines dependable performance with consistent quality to maintain MTTF values exceeding 1000 years at mounting temperatures of +85 °C and is housed in a lead-free / green / RoHS-compliant SOT-363 industry standard SMT package.

The AG203-63 consists of a Darlington-pair amplifier using the high reliability InGap / GaAs HBT process technology and only requires DC-blocking capacitors, a bias resistor, and an inductive RF choke for operation.

The broadband AG203-63 MMIC amplifier can be directly applied to various current and next generation wireless technologies such as GPRS, GSM, CDMA, and WCDMA. In addition, the AG203-63 will work for other various applications from DC to 6 GHz frequency range such as CATV and WiMAX.

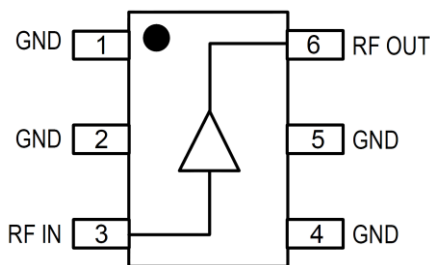


SOT-363 Package

Key Features

- DC – 6000 MHz
- +20 dB Gain at 900 MHz
- +8 dBm Output P1dB at 900 MHz
- +20 dBm OIP3 at 900 MHz
- Single Voltage Supply
- Internally matched to 50 Ω
- Robust 1000 V ESD, Class 1C
- Lead-free / Green / RoHS – compliant SOT-363 package

Functional Block Diagram



Top View

Pin Configuration

| Pin No. | Function |
|------------|------------------|
| 3 | RF Input |
| 6 | RF Output / Bias |
| 1, 2, 4, 5 | Ground |

Applications

- Mobile Infrastructure
- CATV / FTTH
- WLAN / ISM
- RFID
- WiMAX / WiBro

Ordering Information

| Part No. | Description |
|-------------|---|
| AG203-63G | 3,000 pieces on a 7" reel (standard) |
| AG203-63PCB | 700 - 2400 MHz Assembled Evaluation Board |

Absolute Maximum Ratings

| Parameter | Rating |
|---------------------------------------|-------------------|
| Storage Temperature | -55 °C to +125 °C |
| Device Voltage (V _{DEVICE}) | +4.5 V |
| RF Input Power, CW, 50 Ω, T=25 °C | +10 dBm |
| Junction Temperature | 177 °C |

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Recommended Operating Conditions

| Parameter | Min | Typ | Max | Units |
|---|-------|-----|-------|-------|
| DC Supply Voltage | +4.75 | +5 | +5.25 | V |
| T _{CASE} | -40 | | +85 | °C |
| T _{CASE, Operational} | -55 | | +105 | °C |
| T _J for 10 ⁶ hours MTTF | | | +177 | °C |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

| Parameter | Conditions ⁽¹⁾ | Min | Typ | Max | Units |
|-------------------------------------|--|------|-------|------|-------|
| Operational Frequency Range | | DC | | 6000 | MHz |
| Test Frequency | | | 900 | | MHz |
| Gain | | | 19.7 | | dB |
| Input Return Loss | | | 20 | | dB |
| Output Return Loss | | | 16 | | dB |
| Output P1dB | | | +8 | | dBm |
| Output IP3 | P _{out} = -10 dBm/tone, Δf = 10 MHz | | +20.1 | | dBm |
| Output IP2 | | | +24 | | dBm |
| Noise Figure | | | 3.0 | | dB |
| Test Frequency | | | 1900 | | MHz |
| Gain | | 16.8 | 17.8 | 18.8 | dB |
| Output P1dB | | | +7.4 | | dBm |
| Output IP3 | P _{out} = -10 dBm/tone, Δf = 10 MHz | | +19.7 | | dBm |
| Device Voltage | | | 4.05 | | V |
| Device Current | | | 20 | | mA |
| Thermal Resistance, θ _{Jc} | Junction to case | | | 472 | °C/W |

Notes:

1. Test conditions unless otherwise noted: Supply Voltage = +5.0 V, R_{BIAS} = 47.5 Ω, Temp = +25 °C, 50 Ω system.

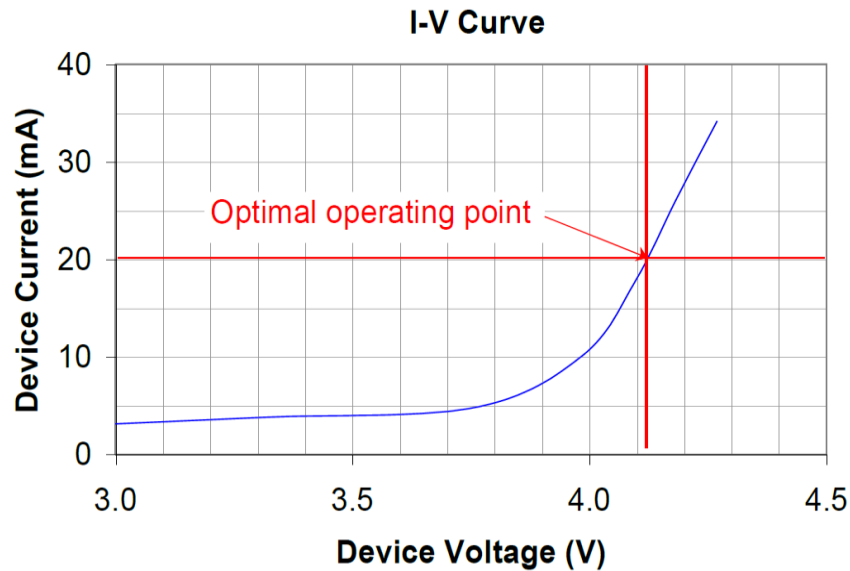
Typical Performance

| Parameter | Typical | | | | | | | | Units |
|---------------------------|---------|-------|-------|-------|-------|-------|------|------|-------|
| Frequency | 100 | 500 | 900 | 1900 | 2140 | 2400 | 3500 | 5800 | MHz |
| S21 | 20.4 | 20.3 | 19.7 | 17.7 | 17.3 | 16.7 | 14.9 | 11.5 | dB |
| S11 | -25 | -25 | -20 | -18 | -16 | -16 | -20 | -20 | dB |
| S22 | -14 | -16 | -16 | -16 | -16 | -16 | -20 | -14 | dB |
| Output P1dB | +8.2 | +8.1 | +8.0 | +7.4 | +6.8 | +6.8 | +6.6 | -- | dBm |
| Output IP3 ⁽¹⁾ | +20.3 | +20.2 | +20.1 | +19.7 | +19.5 | +19.5 | -- | -- | dBm |
| Noise Figure | 2.9 | 2.9 | 3.0 | 3.2 | 3.2 | 3.2 | -- | -- | dB |

Notes:

1. Test conditions unless otherwise stated: Supply Voltage = +5 V, $V_{DEVICE} = +4.05V$, $R_{BIAS} = 47.5 \Omega$, $I_{CC} = 20 \text{ mA}$, $T = 25 \text{ }^\circ\text{C}$, 50Ω system
2. The OIP3 measured with two tones at an output power of -10 dBm / tone separated by 10 MHz. The suppression on the largest IMD3 product is used to calculate the OIP3 using a 2:1 rule.
3. Data is shown as device performance only. Actual implementation for the desired frequency band will be determined by external components shown in the application circuit.

Optimal Operating Bias Point for Typical Performance

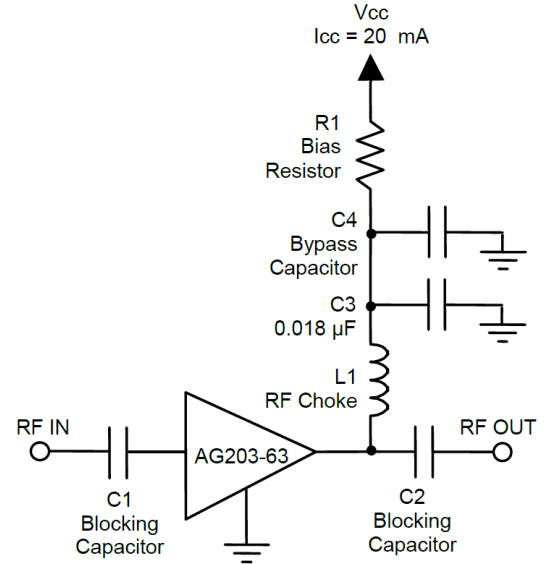
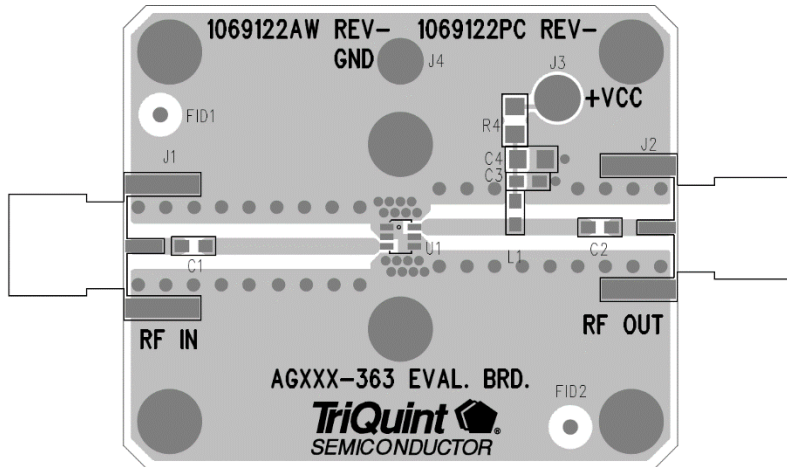


S-Parameters

| Freq (GHz) | S11 (dB) | S11 (ang) | S21 (dB) | S21 (ang) | S12 (dB) | S12 (ang) | S22 (dB) | S22 (ang) |
|------------|----------|-----------|----------|-----------|----------|-----------|----------|-----------|
| 50 | -25.17 | 2.44 | 20.58 | 177.54 | -23.20 | 1.82 | -14.17 | -3.37 |
| 250 | -25.43 | 19.92 | 20.51 | 168.67 | -23.93 | 4.61 | -14.24 | -8.75 |
| 500 | -26.52 | 51.29 | 20.37 | 157.36 | -23.52 | 3.76 | -16.44 | -18.23 |
| 750 | -23.65 | 49.78 | 20.03 | 146.65 | -23.46 | 5.05 | -16.98 | -30.04 |
| 1000 | -22.07 | 40.71 | 19.64 | 136.55 | -23.56 | 2.97 | -17.77 | -41.16 |
| 1250 | -20.63 | 39.53 | 19.22 | 126.53 | -23.03 | 6.36 | -18.33 | -55.53 |
| 1500 | -19.78 | 35.18 | 18.75 | 117.55 | -22.67 | 6.26 | -18.95 | -69.93 |
| 1750 | -19.32 | 28.81 | 18.25 | 108.83 | -22.55 | 8.11 | -19.10 | -85.56 |
| 2000 | -18.82 | 22.65 | 17.69 | 100.49 | -22.09 | 7.05 | -19.08 | -98.01 |
| 2250 | -15.68 | 16.21 | 17.13 | 93.38 | -21.84 | 7.56 | -15.66 | -96.28 |
| 2500 | -16.33 | 9.66 | 16.75 | 88.14 | -21.92 | 3.19 | -16.65 | -105.75 |
| 2750 | -16.81 | 6.23 | 16.32 | 80.77 | -21.04 | 4.47 | -17.53 | -113.94 |
| 3000 | -17.51 | 4.58 | 15.86 | 74.01 | -20.83 | 5.19 | -19.10 | -128.07 |
| 3250 | -18.69 | 6.09 | 15.43 | 67.67 | -20.59 | 5.81 | -20.58 | -142.56 |
| 3500 | -19.88 | 9.58 | 15.01 | 61.27 | -20.34 | 3.51 | -22.15 | -171.10 |
| 3750 | -20.81 | 20.17 | 14.56 | 54.88 | -19.86 | 1.07 | -21.67 | 154.83 |
| 4000 | -21.48 | 40.62 | 14.14 | 48.38 | -19.12 | 0.00 | -19.12 | 134.30 |
| 4250 | -21.14 | 57.36 | 13.76 | 42.54 | -19.02 | -1.99 | -16.77 | 118.64 |
| 4500 | -19.74 | 72.23 | 13.30 | 36.58 | -18.70 | -6.17 | -14.99 | 108.52 |
| 4750 | -19.01 | 82.70 | 12.91 | 30.19 | -18.67 | -7.40 | -14.02 | 104.45 |
| 5000 | -18.41 | 89.08 | 12.54 | 24.69 | -18.26 | -10.48 | -13.28 | 102.92 |
| 5250 | -19.09 | 94.75 | 12.18 | 19.42 | -18.05 | -12.75 | -13.13 | 100.56 |
| 5500 | -20.88 | 99.20 | 11.82 | 14.41 | -17.84 | -14.26 | -13.43 | 100.66 |
| 5750 | -23.32 | 109.55 | 11.60 | 9.32 | -17.44 | -17.25 | -14.24 | 103.15 |

Test conditions unless otherwise noted: $V_{\text{DEVICE}} = +4.05 \text{ V}$, $I_{\text{CC}} = 20 \text{ mA}$, $T = 25 \text{ }^\circ\text{C}$, calibrated reference planes to device leads

700 MHz to 2400 MHz Evaluation Board – AG203-63PCB



Bill of Material – AG203-63PCB, 700 MHz to 2400 MHz

| Reference Des. | Value | Description | Manuf. | Part Number |
|----------------|----------|---|---------|-------------|
| n/a | n/a | Printed Circuit Board | Qorvo | |
| U1 | n/a | Amplifier, AG203-63G | Qorvo | AG203-63G |
| L1 | 39 nH | Inductor, 39 nH, Wire wound, 0603, RF Choke | various | |
| C1, C2 | 56 pF | Capacitor, 56 pF, Chip, 0603, DC Blocking | various | |
| C3 | 0.018 µF | Capacitor, 0.018 µF, Chip, 0603, Bypass | various | |
| C4 | | Capacitor, Not Place, Bypass | | |
| R1 | 47.5 Ω | Resistor, 47.5 Ω, 1%, 0603, Bias | various | |

Notes: This BOM configuration provides optimum broadband performance of the fully assembled evaluation board shipped from Qorvo.

Component Values for Specific Frequencies

| Frequency | 50 MHz | 500 MHz | 900 MHz | 1900 MHz | 2200 MHz | 2500 MHz | 3500 MHz |
|------------|---------|---------|---------|----------|----------|----------|----------|
| L1 | 820 nH | 220 nH | 68 nH | 27 nH | 22 nH | 18 nH | 15 nH |
| C1, C2, C4 | .018 µF | 1000 pF | 100 pF | 68 pF | 68 pF | 56 pF | 39 pF |

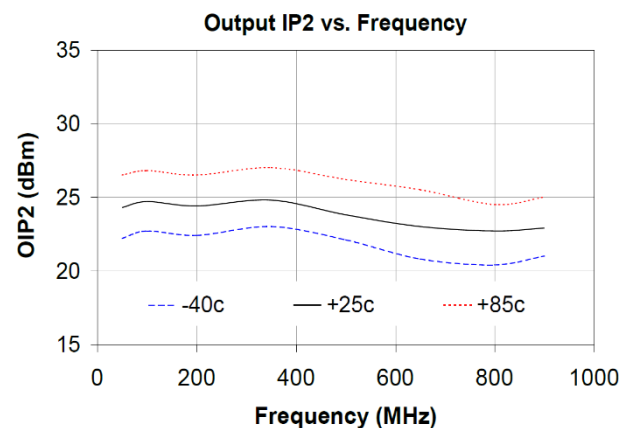
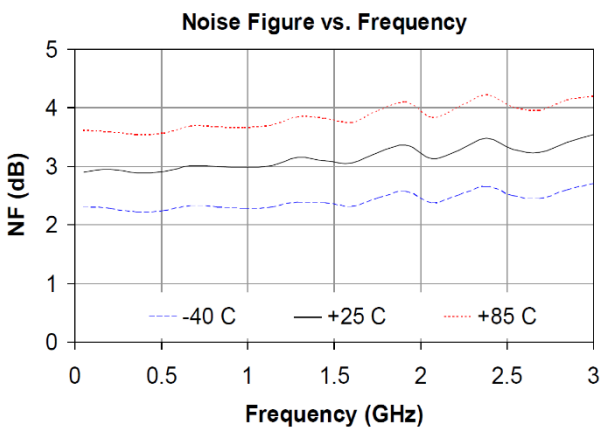
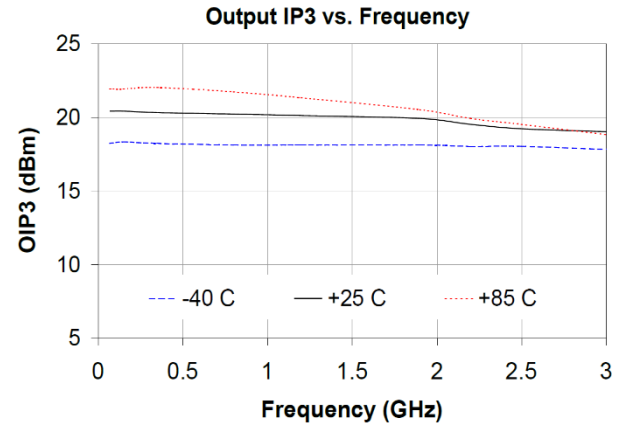
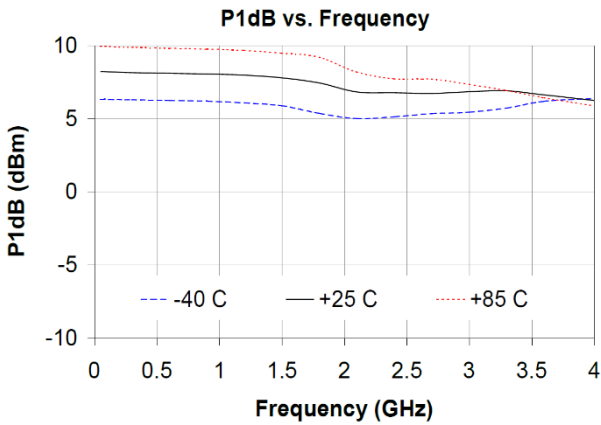
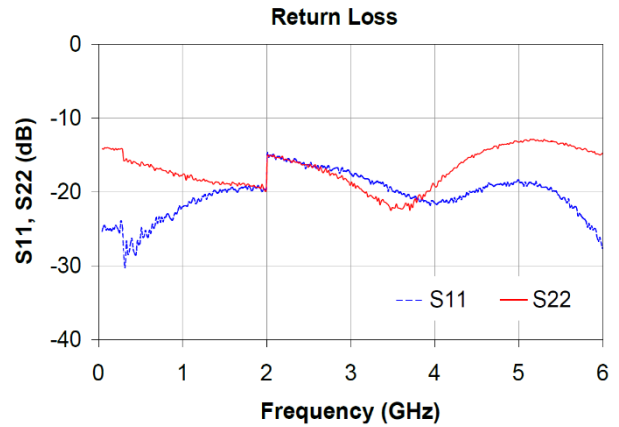
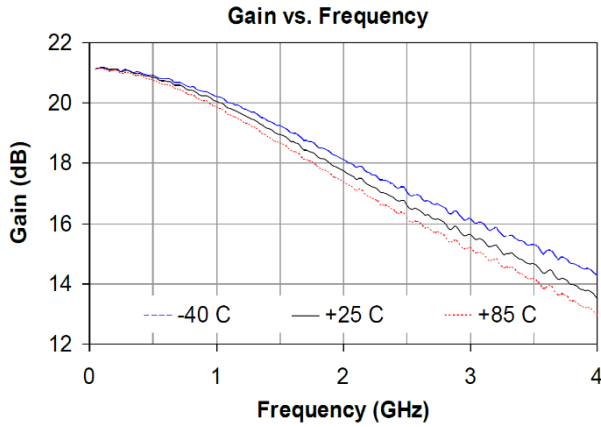
Bias Resistor Values for Specific Supply Voltages

| V _{SUPPLY} | 5 V | 6 V | 7 V | 8 V | 9 V | 10 V | 12 V |
|---------------------|--------|------|-------|-------|-------|-------|-------|
| R1 | 47.5 Ω | 98 Ω | 148 Ω | 198 Ω | 248 Ω | 298 Ω | 398 Ω |
| Component Size | 0603 | 0603 | 0805 | 0805 | 1206 | 1210 | 1210 |

Notes: The R1 is for bias and its stability over temperature. The minimum V_{SUPPLY} is +5 V. An 1% tolerance resistor is recommended.

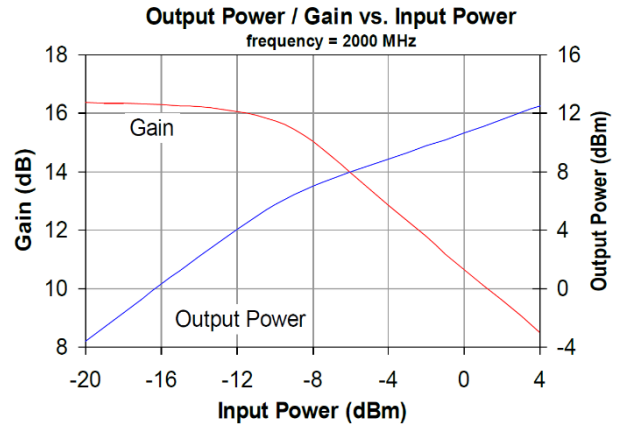
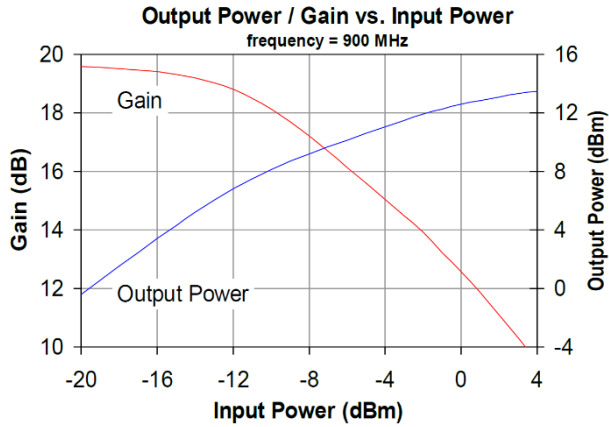
Performance Plots, +5 V Supply Voltage

Test conditions unless otherwise stated: Supply Voltage = +5 V, $V_{DEVICE} = +4.05V$, $R_{BIAS} = 47.5 \Omega$, $I_{CC} = 20 \text{ mA}$, $T = 25 \text{ }^\circ\text{C}$, 50Ω system



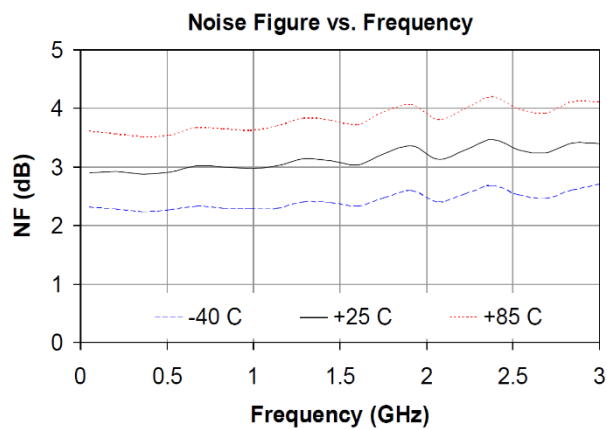
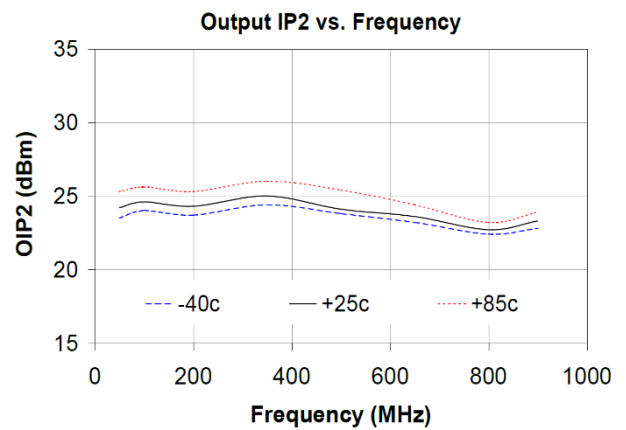
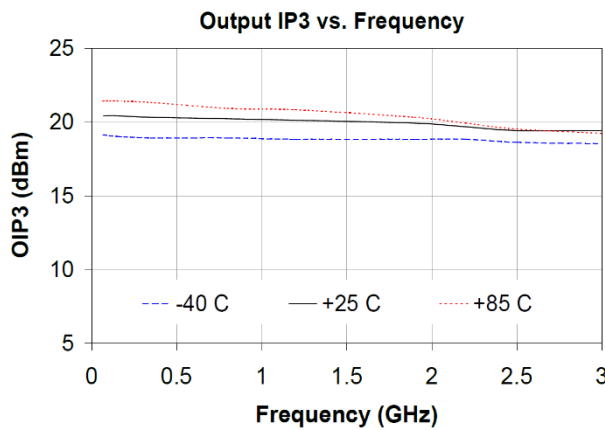
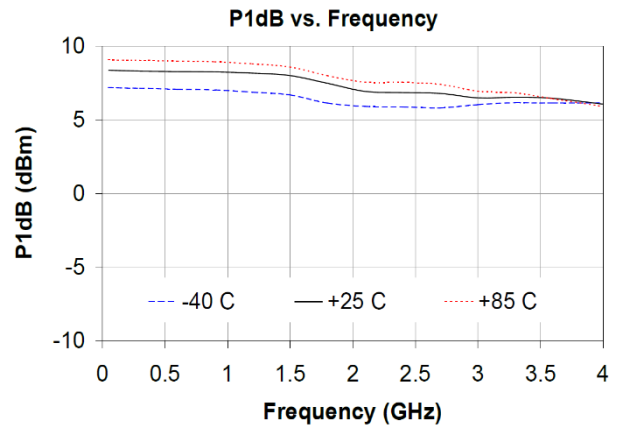
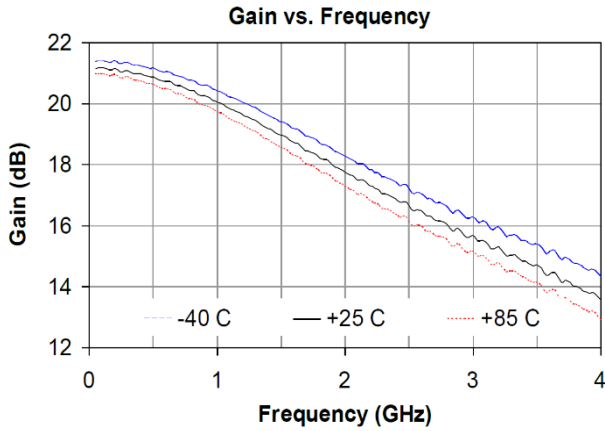
Performance Plots, +5 V Supply Voltage (continue)

Test conditions unless otherwise noted: Supply Voltage = +5 V, $V_{DEVICE} = +4.05V$, $R_{BIAS} = 47.5\ \Omega$, $I_{CC} = 20\ mA$, $T = 25\ ^\circ C$, $50\ \Omega$ system



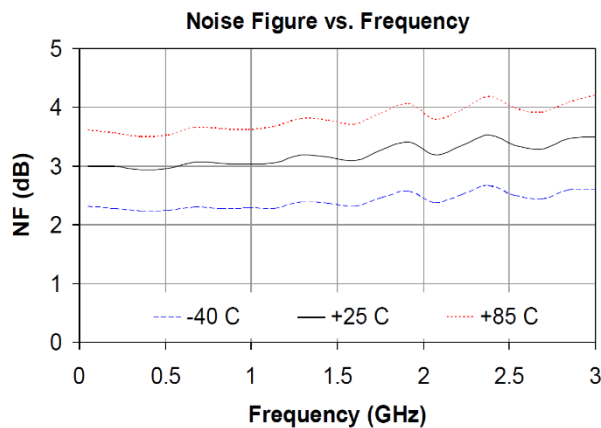
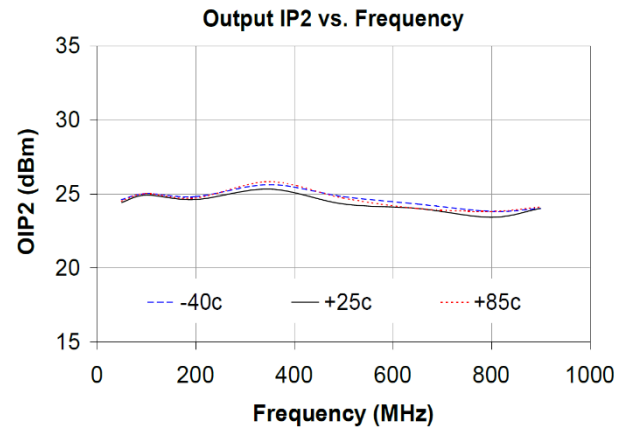
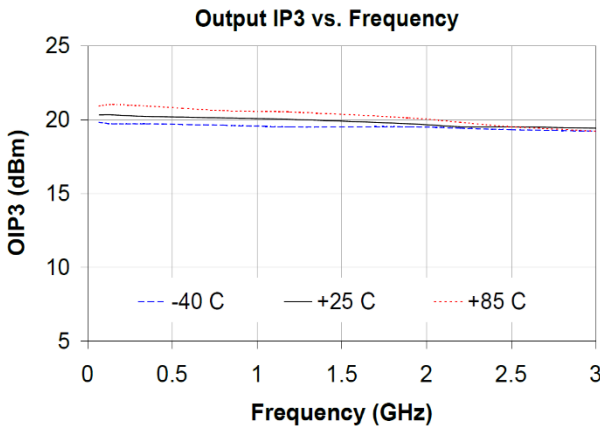
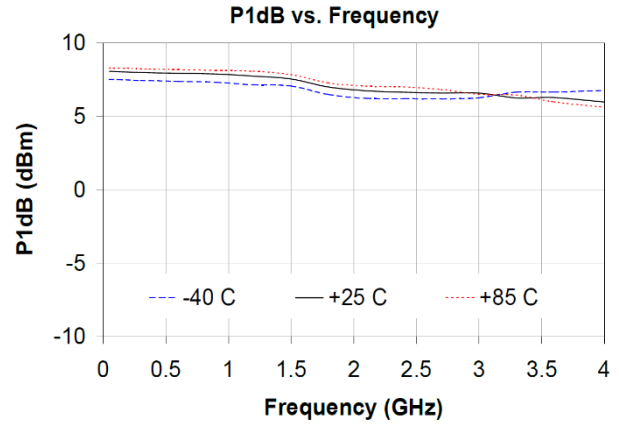
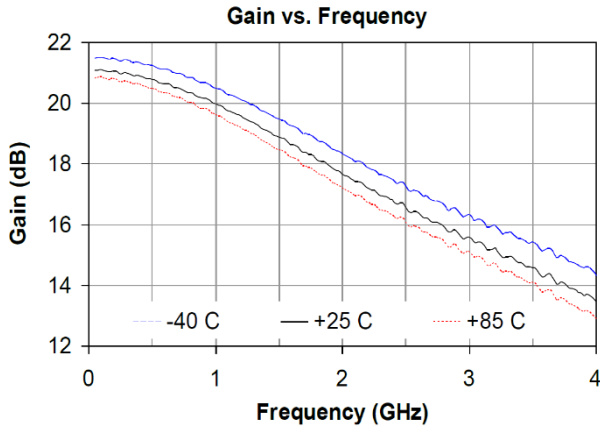
Performance Plots, +6 V Supply Voltage

Test conditions unless otherwise stated: Supply Voltage = +6 V, $V_{DEVICE} = +4.05V$, $R_{BIAS} = 98 \Omega$, $I_{CC} = 20 \text{ mA}$, $T = 25 \text{ }^\circ\text{C}$, 50Ω system



Performance Plots, +8 V Supply Voltage

Test conditions unless otherwise stated: Supply Voltage = +8 V, $V_{DEVICE} = +4.05V$, $R_{BIAS} = 198 \Omega$, $I_{CC} = 20 \text{ mA}$, $T = 25 \text{ }^\circ\text{C}$, 50Ω system



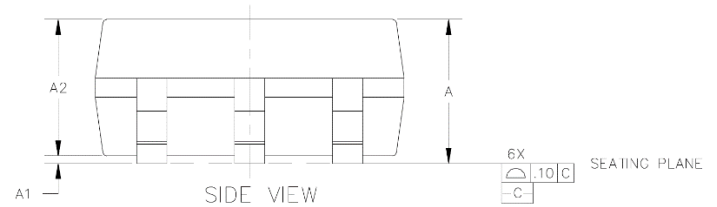
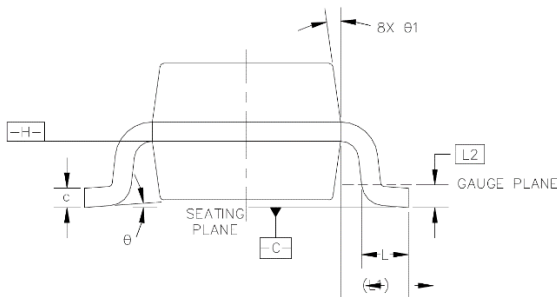
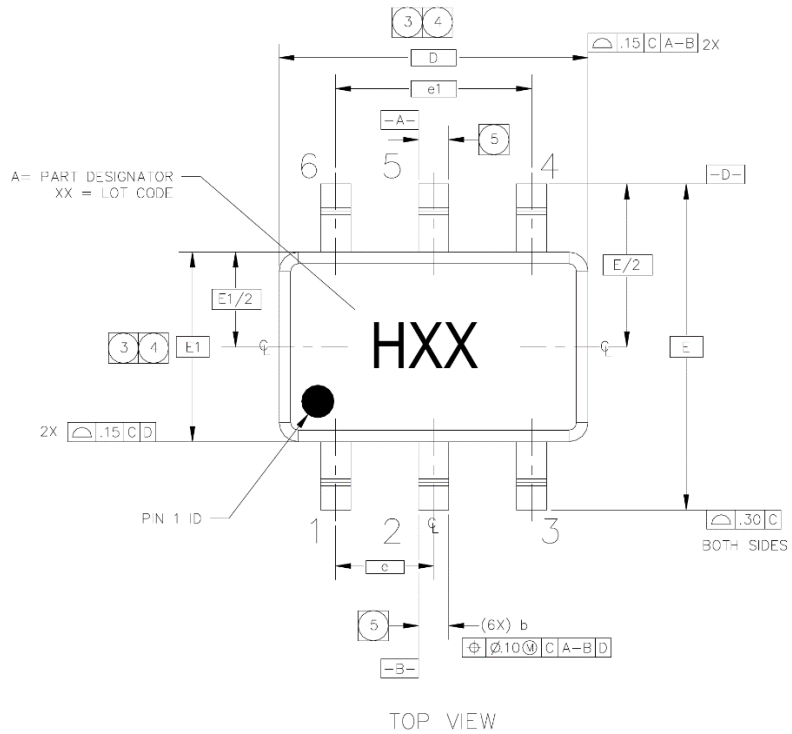
Package Marking and Dimensions

Marking: HXX

H – Designator

XX – 2 Digit Lot Code

| SYMBOL | MIN | MAX |
|------------|----------------|----------------|
| A | — | 1.10 (.043) |
| A1 | 0 | .10 (.004) |
| A2 | .70 (.028) | 1.00 (.039) |
| D | 2.00 (.079) | BASIC |
| E | 2.10 (.083) | BASIC |
| E1 | 1.25 (.039) | BASIC |
| L | .21 (.008) | .41 (.016) |
| L1 | .42 (.017) | RFF |
| L2 | .15 (.006) | BASIC |
| θ | 0° | 8° |
| θ_1 | 4° | 12° |
| b | .15 (.006) | .30 (.012) |
| c | .08 (.003) | .22 (.009) |
| e | .65 (.026) | BASIC |
| e1 | 1.30 (.051) | BASIC |



NOTES:

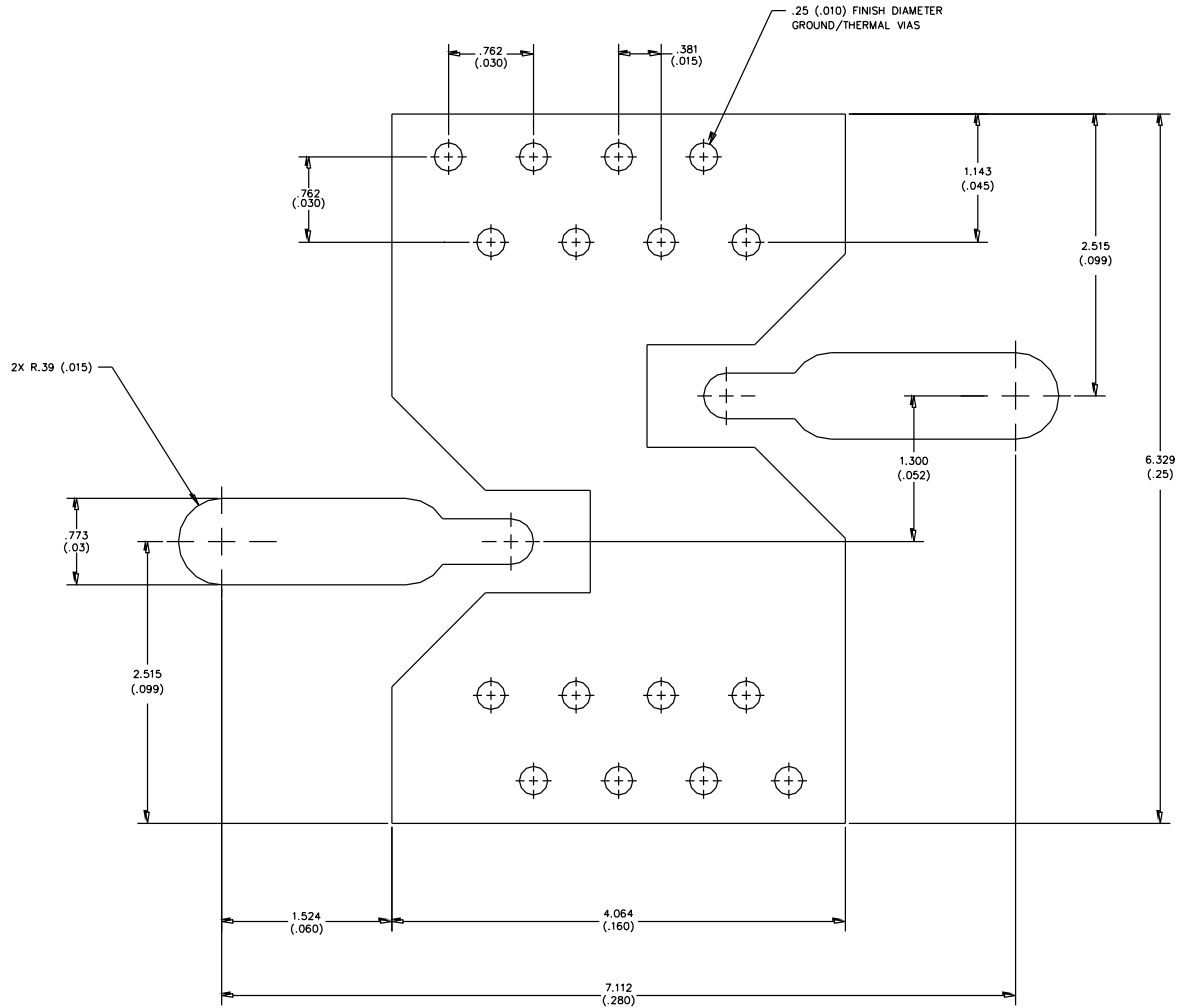
- DIMENSIONS AND TOLERANCING PER ASME Y14.5M-1194. PACKAGE CONFORMS TO JEDEC MO-203, ISSUE B.
- DIMENSIONS ARE IN MILLIMETERS (INCHES).
- DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 mm PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM H.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, I.E. BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND THE BOTTOM OF THE PLASTIC BODY. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM H.

- DATUM A & B TO BE DETERMINED AT DATUM H.
- DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 mm TOTAL IN EXCESS OF THE "b" DIMENSION AT MAXIMUM MATERIAL CONDITION. THE DAMBAR IS NOT LOCATED ON THE LOWER RADIUS OF THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07 mm.

Notes:

- All dimensions are in millimeters with (inches). Angles are in degrees.
- The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.

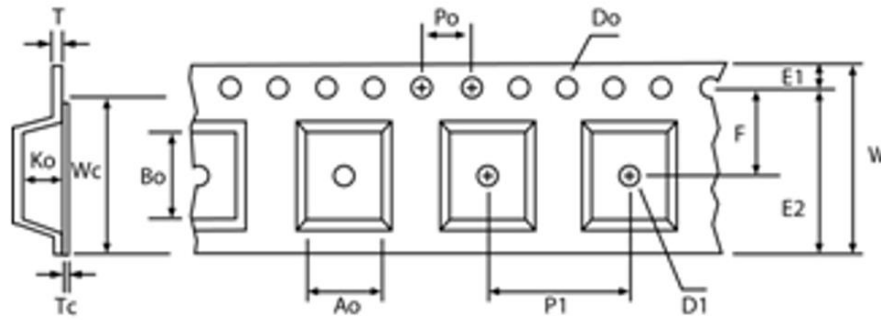
PCB Mounting Land Pattern



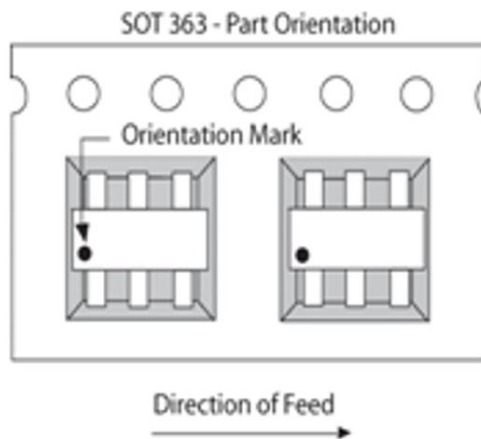
Notes:

1. Ground / thermal via holes are critical for the proper performance of this device. Via holes should use a 0.35 mm (#80 / .0135") diameter drill and have a final plated thru diameter of 0.25 mm (0.010").
2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
3. Mounting screws can be added near the part to fasten the board to a heatsink. Ensure that the ground / thermal via region contacts the heatsink.
4. No solder mask on the backside of the PC board in the region where the board contacts the heatsink.
5. RF trace width depends upon the PC board material and construction.
6. Use 1 oz. Copper minimum.
7. All dimensions are in millimeters (inches). Angles are in degrees.

Tape and Reel Information – Carrier and Cover Tape Dimensions

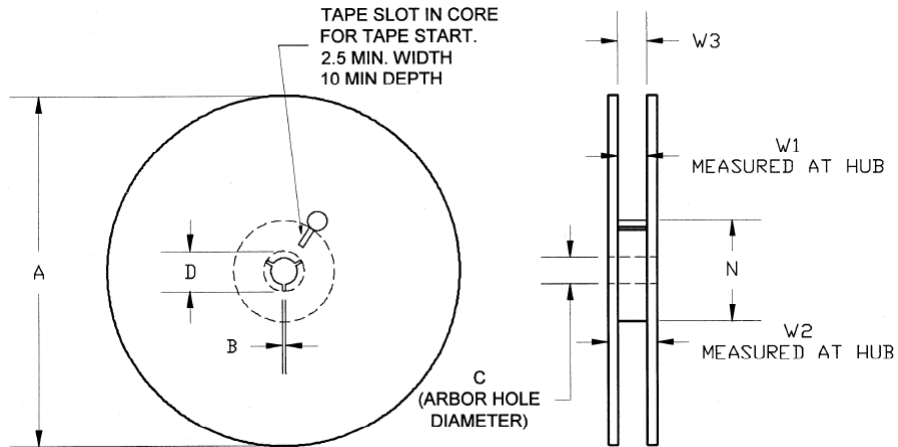


| Feature | Measure | Symbol | Size (in) | Size (mm) |
|---------------------|--|--------|-----------|-----------|
| Cavity | Length | A0 | 0.089 | 2.25 |
| | Width | B0 | 0.094 | 2.40 |
| | Depth | K0 | 0.047 | 1.20 |
| | Pitch | P1 | 0.157 | 4.00 |
| Centerline Distance | Cavity to Perforation - Length Direction | P2 | 0.079 | 2.00 |
| | Cavity to Perforation - Width Direction | F | 0.138 | 3.50 |
| Cover Tape | Width | C | 0.213 | 5.40 |
| Carrier Tape | Width | W | 0.315 | 8.00 |



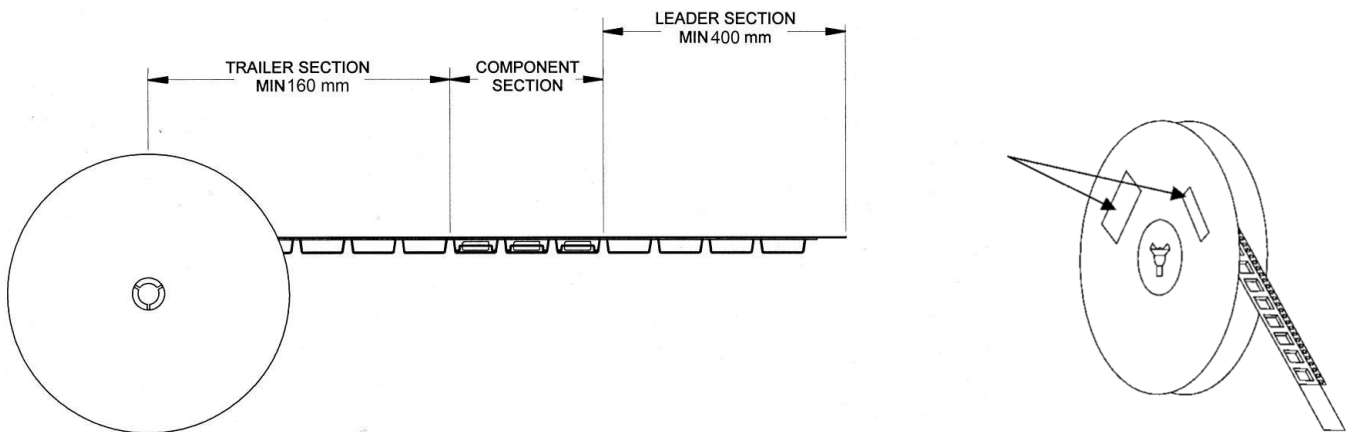
Tape and Reel Information – Reel Dimensions

Standard T/R size = 3,000 pieces on a 7" reel.



| Feature | Measure | Symbol | Size (in) | Size (mm) |
|---------|----------------------|--------|-----------|-----------|
| Flange | Diameter | A | 6.969 | 177.0 |
| | Thickness | W2 | 0.559 | 14.2 |
| | Space Between Flange | W1 | 0.346 | 8.8 |
| Hub | Outer Diameter | N | 2.283 | 58.0 |
| | Arbor Hole Diameter | C | 0.512 | 13.0 |
| | Key Slit Width | B | 0.079 | 2.0 |
| | Key Slit Diameter | D | 0.787 | 20.0 |

Tape and Reel Information – Tape Length and Label Placement



- Notes:
1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
 2. Labels are placed on the flange opposite the sprockets in the carrier tape.

Handling Precautions

| Parameter | Rating | Standard |
|----------------------------------|----------|--------------------------|
| ESD – Human Body Model (HBM) | Class 1C | ESDA / JEDEC JS-001-2012 |
| ESD – Charged Device Model (CDM) | Class C3 | JEDEC JESD22-C101F |
| MSL – Moisture Sensitivity Level | Level 3 | IPC/JEDEC J-STD-020 |



Caution!
ESD-Sensitive Device

Solderability

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes. Solder profiles available upon request.

Contact plating: Matte Tin

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free



Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com

Tel: 1-844-890-8163

Email: customer.support@qorvo.com

For technical questions and application information:

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- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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